# **PDTD123Y series**

NPN 500 mA, 50 V resistor-equipped transistors;R1 = 2.2 kΩ, R2 = 10 kΩRev. 02 — 16 November 2009Pro

**Product data sheet** 

# 1. Product profile

## 1.1 General description

500 mA NPN Resistor-Equipped Transistors (RET) family.

#### Table 1. Product overview

| Type number              | Package |        | PNP complement |           |
|--------------------------|---------|--------|----------------|-----------|
|                          | NXP     | JEITA  | JEDEC          |           |
| PDTD123YK                | SOT346  | SC-59A | TO-236         | PDTB123YK |
| PDTD123YS <sup>[1]</sup> | SOT54   | SC-43A | TO-92          | PDTB123YS |
| PDTD123YT                | SOT23   | -      | TO-236AB       | PDTB123YT |

[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

## 1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 500 mA output current capability

## **1.3 Applications**

- Digital application in automotive and industrial segment
- Controlling IC inputs

## 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol Conditions Parameter Min Тур Max Unit V VCFO collector-emitter voltage open base --50 output current (DC) --500 mΑ  $I_0$ bias resistor 1 (input) R1 1.54 2.2 2.86 kΩ R2/R1 bias resistor ratio 4.1 4.55 5



- Reduces component count
- Reduces pick and place costs
- ±10 % resistor ratio tolerance
- Cost saving alternative for BC817 series in digital applications
- Switching loads

# 2. Pinning information

| Pin      | Description        | Simplified outline  | Symbol                  |
|----------|--------------------|---|-------------------------|
| SOT54    |                    |   |                         |
| 1        | input (base)       |   |                         |
| 2        | output (collector) |   |                         |
| 3        | GND (emitter)      |   |                         |
| SOT54A   |                    |   |                         |
| 1        | input (base)       |   |                         |
| 2        | output (collector) |   |                         |
| 3        | GND (emitter)      | 1<br>2<br>001aab348   | 1 R1<br>R2<br>006aaa145 |
| SOT54 va | ariant             |   |                         |
| 1        | input (base)       |   |                         |
| 2        | output (collector) |   |                         |
| 3        | GND (emitter)      | ()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>()<br>( | 1 R1<br>R2<br>006aaa145 |
| SOT23, S | OT346              |   |                         |
| 1        | input (base)       |   |                         |
| 2        | GND (emitter)      | 3   |                         |
| 3        | output (collector) | 12  | 1<br>R2<br>sym007       |

## 3. Ordering information

| Table 4. Ordering information |         |   |         |  |  |  |
|-------------------------------|---------|---|---------|--|--|--|
| Type number                   | Package | age   |         |  |  |  |
|                               | Name    | Description   | Version |  |  |  |
| PDTD123YK                     | SC-59A  | plastic surface mounted package; 3 leads                    | SOT346  |  |  |  |
| PDTD123YS <sup>[1]</sup>      | SC-43A  | plastic single-ended leaded (through hole) package; 3 leads | SOT54   |  |  |  |
| PDTD123YT                     | -       | plastic surface mounted package; 3 leads                    | SOT23   |  |  |  |
|                               |         |   |         |  |  |  |

[1] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

## 4. Marking

### Table 5.Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PDTD123YK   | E7                          |
| PDTD123YS   | D123YS                      |
| PDTD123YT   | *7X                         |

- [1] \* = -: made in Hong Kong
  - \* = p: made in Hong Kong
  - \* = t: made in Malaysia
  - \* = W: made in China

# 5. Limiting values

#### Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions                   | Min | Мах  | Unit |
|------------------|---------------------------|------------------------------|-----|------|------|
|                  |                           |                              |     | 50   | V    |
| V <sub>CBO</sub> | collector-base voltage    | open emitter                 | -   |      |      |
| V <sub>CEO</sub> | collector-emitter voltage | open base                    | -   | 50   | V    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector               | -   | 5    | V    |
| VI               | input voltage             |                              |     |      |      |
|                  | positive                  |                              | -   | +12  | V    |
|                  | negative                  |                              | -   | -5   | V    |
| lo               | output current (DC)       |                              | -   | 500  | mA   |
| P <sub>tot</sub> | total power dissipation   | $T_{amb} \le 25 \ ^{\circ}C$ | [1] |      |      |
|                  | SOT346                    |                              | -   | 250  | mW   |
|                  | SOT54                     |                              | -   | 500  | mW   |
|                  | SOT23                     |                              | -   | 250  | mW   |
| T <sub>stg</sub> | storage temperature       |                              | -65 | +150 | °C   |
| Tj               | junction temperature      |                              | -   | 150  | °C   |
| T <sub>amb</sub> | ambient temperature       |                              | -65 | +150 | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# 6. Thermal characteristics

| Table 7.             | Thermal characteristics                     | 5           |            |     |     |      |
|----------------------|---|-------------|------------|-----|-----|------|
| Symbol               | Parameter                                   | Conditions  | Min        | Тур | Max | Unit |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air | <u>[1]</u> |     |     |      |
|                      | SOT346                                      |             | -          | -   | 500 | K/W  |
|                      | SOT54                                       |             | -          | -   | 250 | K/W  |
|                      | SOT23                                       |             | -          | -   | 500 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

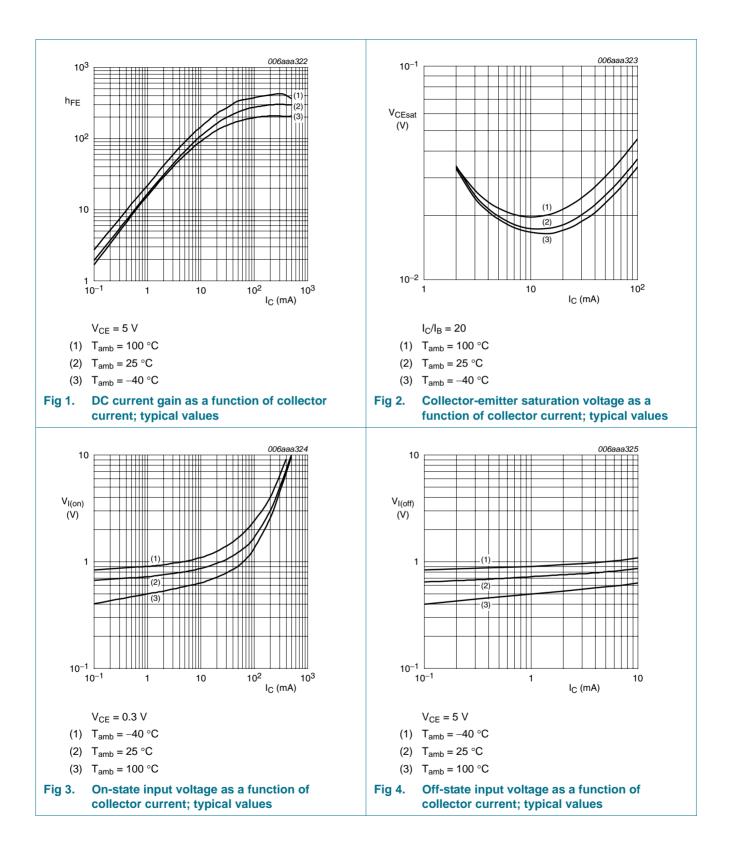
# 7. Characteristics

| Symbol              | Parameter                               | Conditions   | Min  | Тур  | Max  | Unit |
|---------------------|---|--|------|------|------|------|
| I <sub>CBO</sub> c  | collector-base cut-off                  | $V_{CB} = 40 \text{ V}; I_E = 0 \text{ A}$           | -    | -    | 100  | nA   |
|                     | current                                 | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$           | -    | -    | 100  | nA   |
| I <sub>CEO</sub>    | collector-emitter<br>cut-off current    | $V_{CE} = 50 \text{ V}; \text{ I}_{B} = 0 \text{ A}$ | -    | -    | 0.5  | μA   |
| I <sub>EBO</sub>    | emitter-base cut-off<br>current         | $V_{EB} = 5 V; I_C = 0 A$                            | -    | -    | 0.65 | mA   |
| h <sub>FE</sub>     | DC current gain                         | $V_{CE} = 5 \text{ V}; I_{C} = 50 \text{ mA}$        | 70   | -    | -    |      |
| V <sub>CEsat</sub>  | collector-emitter<br>saturation voltage | $I_{\rm C}$ = 50 mA; $I_{\rm B}$ = 2.5 mA            | -    | -    | 0.3  | V    |
| V <sub>I(off)</sub> | off-state input voltage                 | $V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A                  | 0.4  | 0.6  | 1    | V    |
| V <sub>I(on)</sub>  | on-state input voltage                  | $V_{CE}$ = 0.3 V; $I_{C}$ = 20 mA                    | 0.5  | 1    | 1.4  | V    |
| R1                  | bias resistor 1 (input)                 |  | 1.54 | 2.2  | 2.86 | kΩ   |
| R2/R1               | bias resistor ratio                     |  | 4.1  | 4.55 | 5    |      |
| Cc                  | collector capacitance                   | $V_{CB}$ = 10 V; $I_E$ = $i_e$ = 0 A;<br>f = 1 MHz   | -    | 7    | -    | pF   |

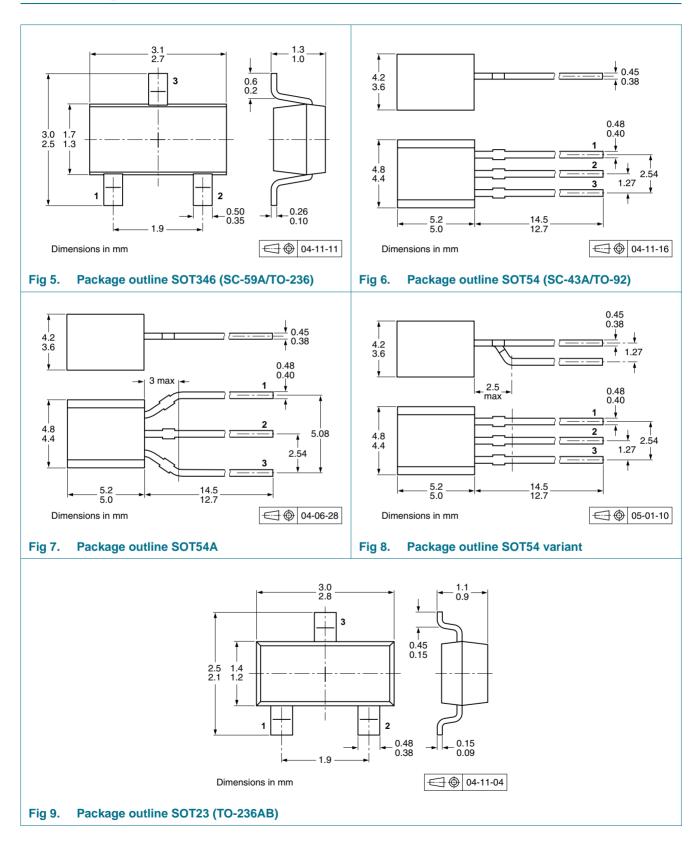
#### Table 8.Characteristics

# **PDTD123Y series**

#### NPN 500 mA resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 10 k $\Omega$



## 8. Package outline



# 9. Packing information

| Type number | Package       | Description                    | Packin | g quanti | ty    |
|-------------|---------------|--------------------------------|--------|----------|-------|
|             |               |                                | 3000   | 5000     | 10000 |
| PDTD123YK   | SOT346        | 4 mm pitch, 8 mm tape and reel | -115   | -        | -135  |
| PDTD123YS   | SOT54         | bulk, straight leads           | -      | -412     | -     |
|             | SOT54A        | tape and reel, wide pitch      | -      | -        | -116  |
|             |               | tape ammopack, wide pitch      | -      | -        | -126  |
|             | SOT54 variant | bulk, delta pinning            | -      | -112     | -     |
| PDTD123YT   | SOT23         | 4 mm pitch, 8 mm tape and reel | -215   | -        | -235  |

[1] For further information and the availability of packing methods, see <u>Section 12</u>.

# **10. Revision history**

| Table 10. Revision hi | story        |  |               |                |
|-----------------------|--------------|--|---------------|----------------|
| Document ID           | Release date | Data sheet status  | Change notice | Supersedes     |
| PDTD123Y_SER_2        | 20091116     | Product data sheet   | -             | PDTD123Y_SER_1 |
| Modifications:        |              | eet was changed to reflect<br>w legal definitions and disc |               |                |
| PDTD123Y_SER_1        | 20050412     | Product data sheet   | -             | -              |

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## **11.1** Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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